

Microcontroller Interfacing

Output Levels

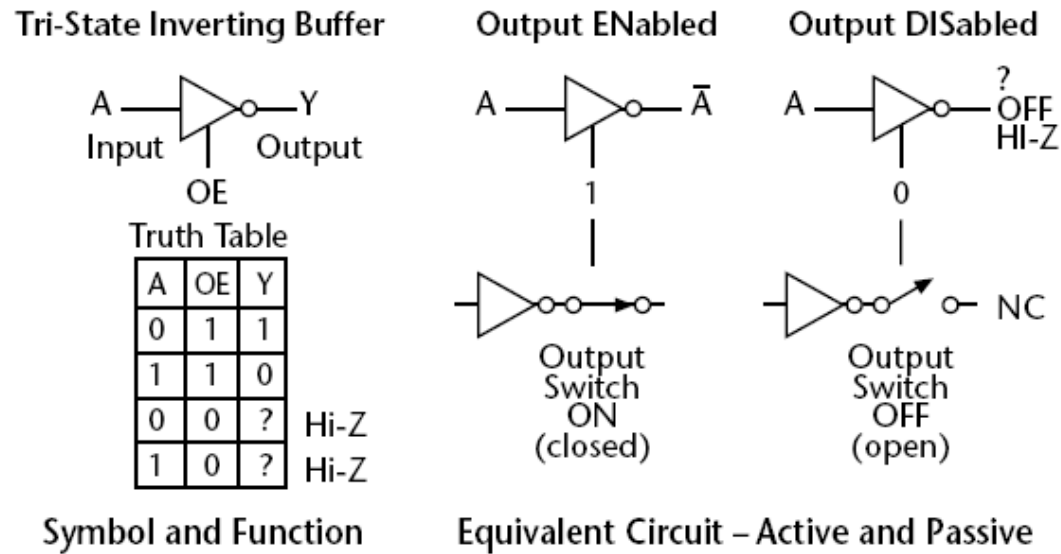


Figure 1-19: Active and passive states of a tri-state buffer.

Interpretation of Timing Diagrams

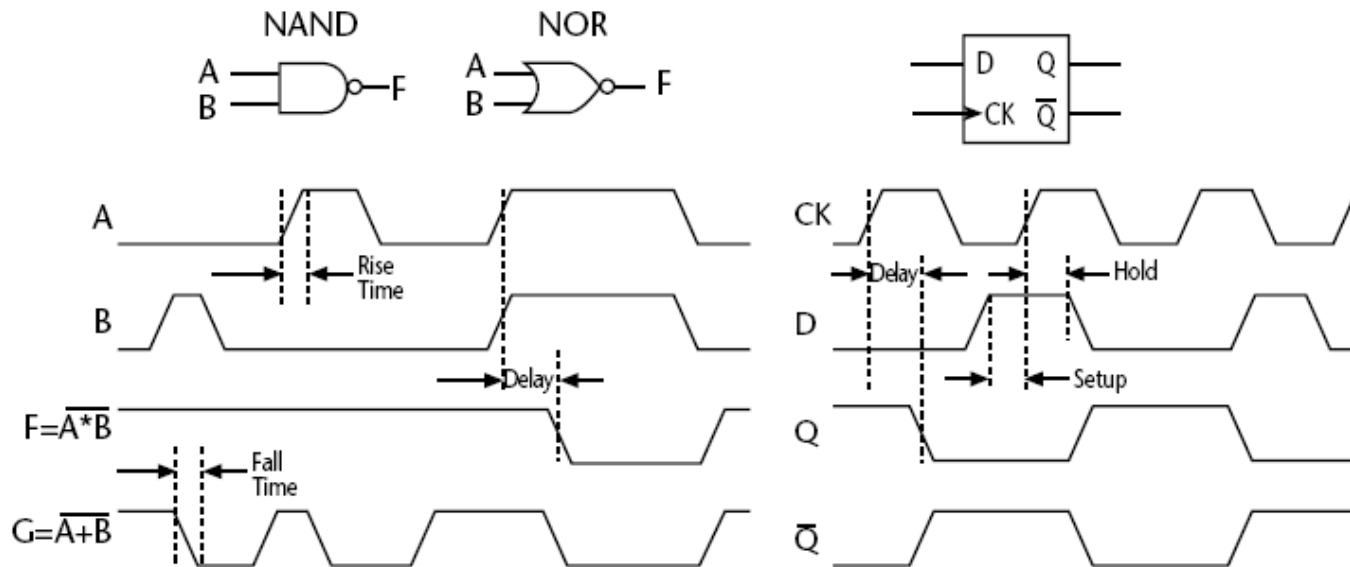
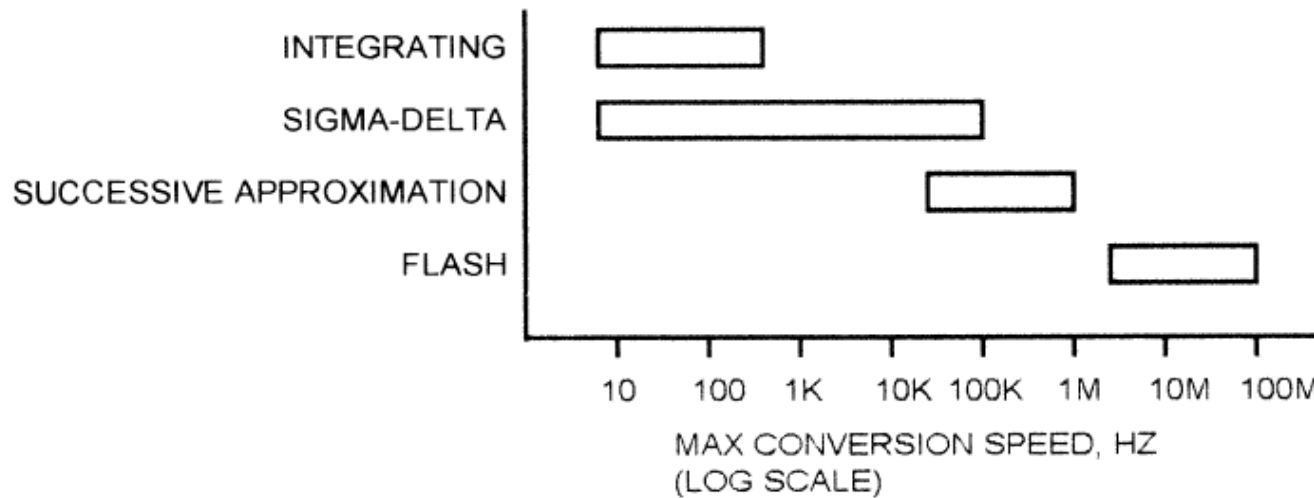
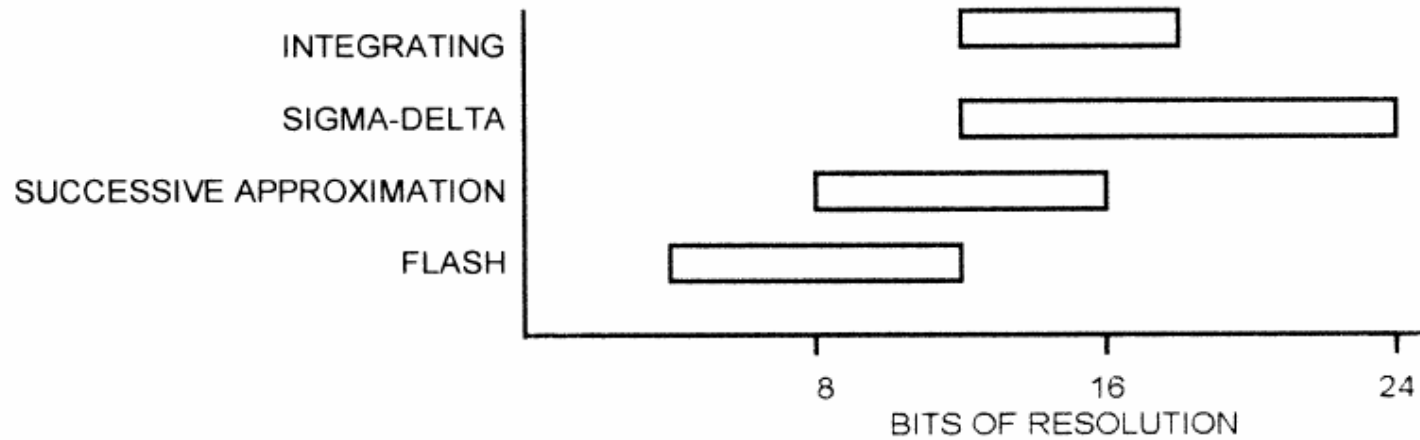


Figure 1-20: Timing diagram notation examples.

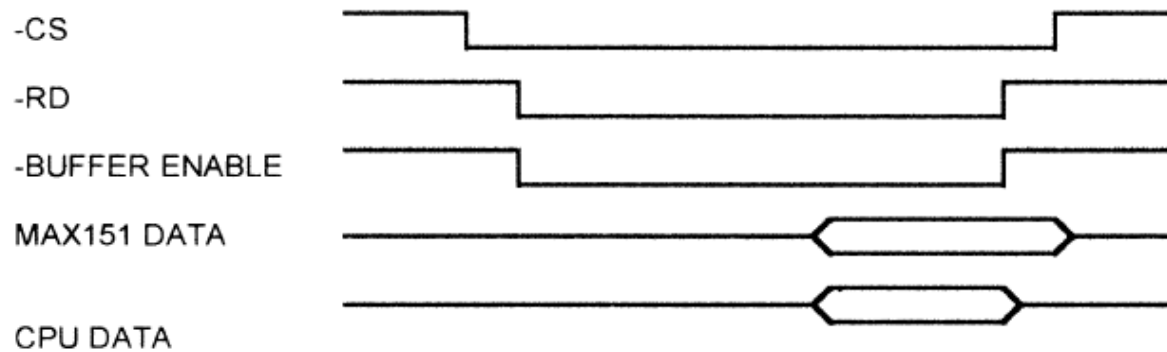
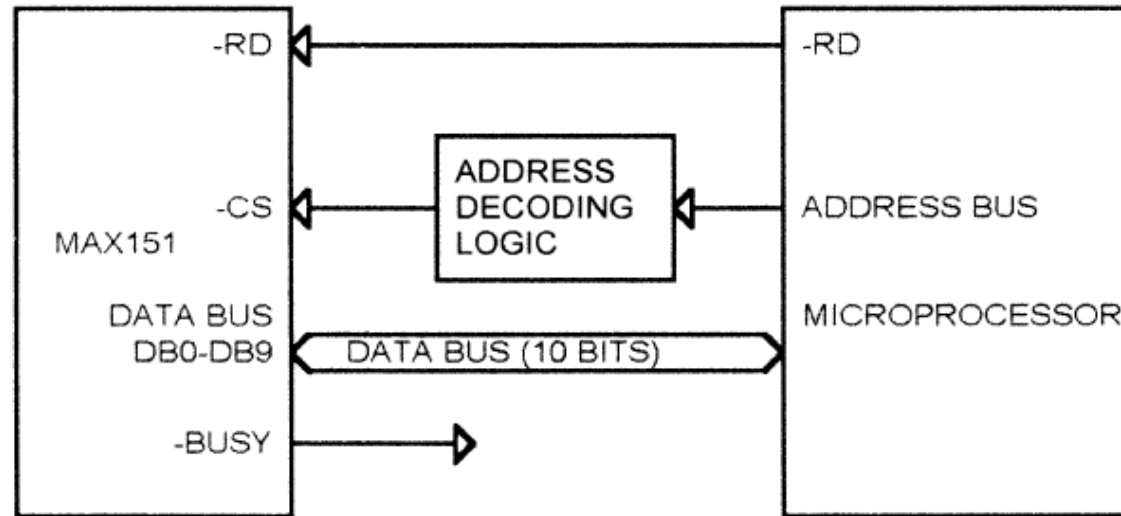
Analog to Digital Converters

- Sampling rate (MHZ)
- Sampling resolution (bits)
- Interface type (parallel or serial)
- Reference voltage (volt)
- Input range (unipolar or bipolar)
- Sample-and-hold circuit usually inside chip
- Note: Analog antialiasing filter must be in place

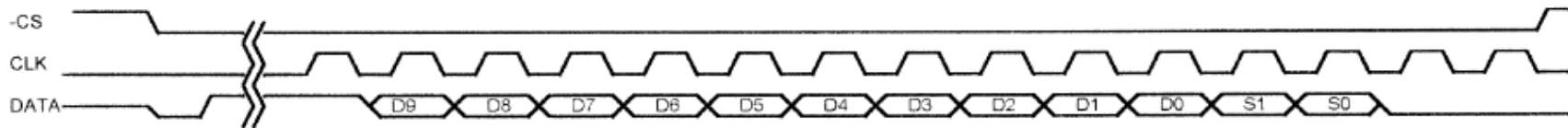
ADC Technologies



Parallel Interface Example

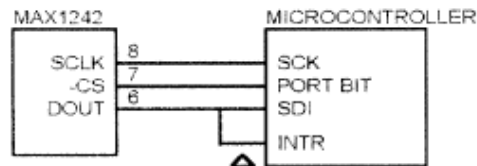
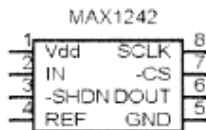


Serial Interface Example



MAX1242 DRIVES DOUT HIGH WHEN CONVERSION IS COMPLETE

CONVERSION STARTS WITH FALLING EDGE OF -CS



THIS CONNECTION PROVIDES AN INTERRUPT WHEN CONVERSION IS COMPLETE

Memory

- External interface possible in most cases
- Nonvolatile EPROM
- Volatile RAM (SRAM, DRAM, etc.)
- Nonvolatile EEPROM
- Nonvolatile FLASH
- Refer to timing diagram for each to know how to interface with microcontroller

Temperature Sensors

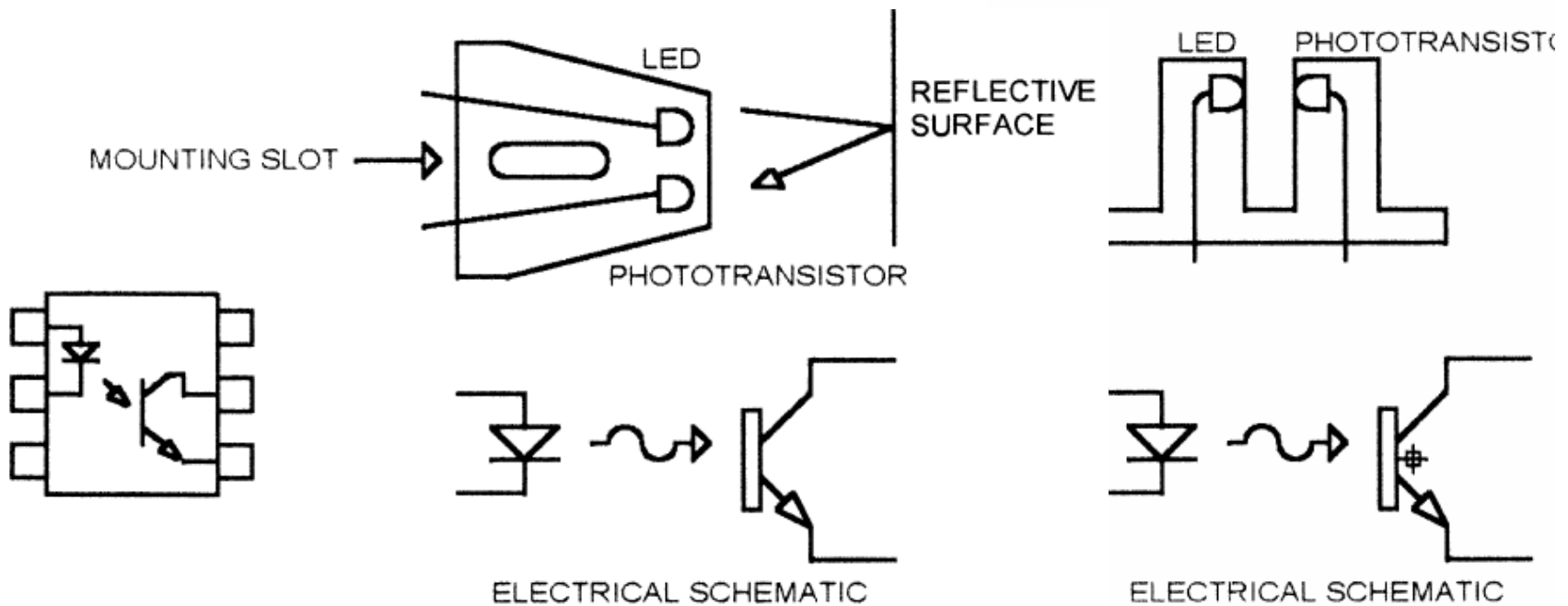
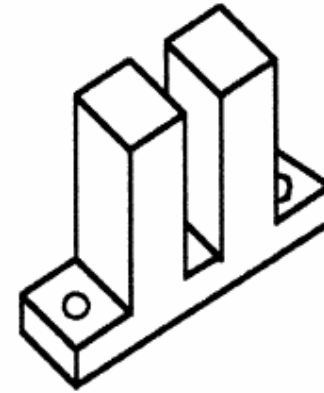
- Thermistors (PTC, NTC)

Typical NTC Thermistor Data

<i>Temp °C</i>	<i>R/R₂₅</i>	<i>Temp °C</i>	<i>R/R₂₅</i>
-50	39.03	30	.8276
-40	21.47	40	.6406
-30	12.28	50	.5758
-20	7.28	60	.4086
-10	4.46	70	.2954
0	2.81	80	.2172
10	1.82	90	.1622
20	1.21	100	.1229
25	1.00	110	.09446

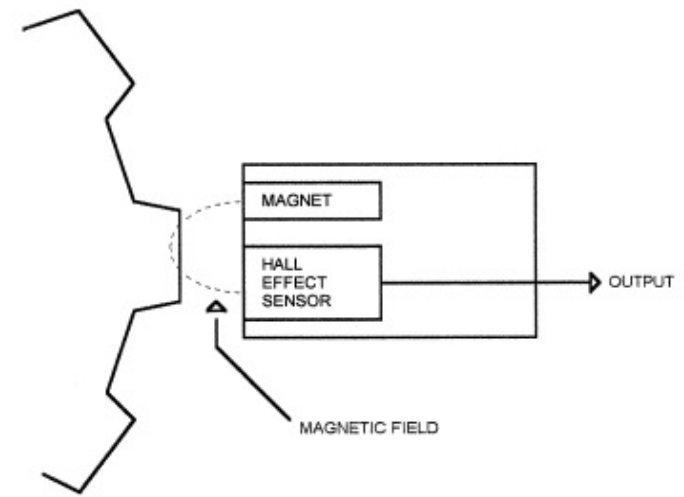
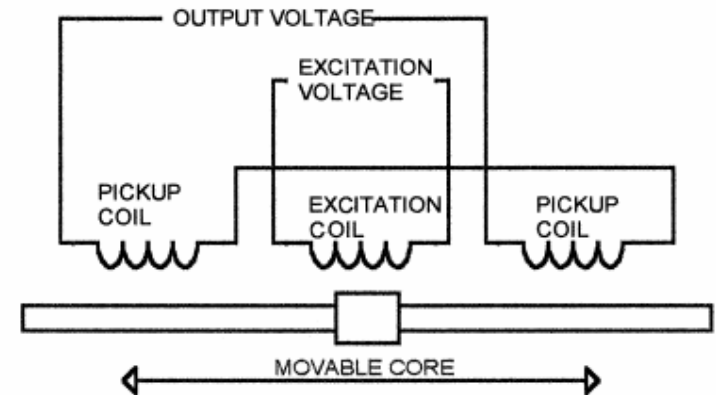
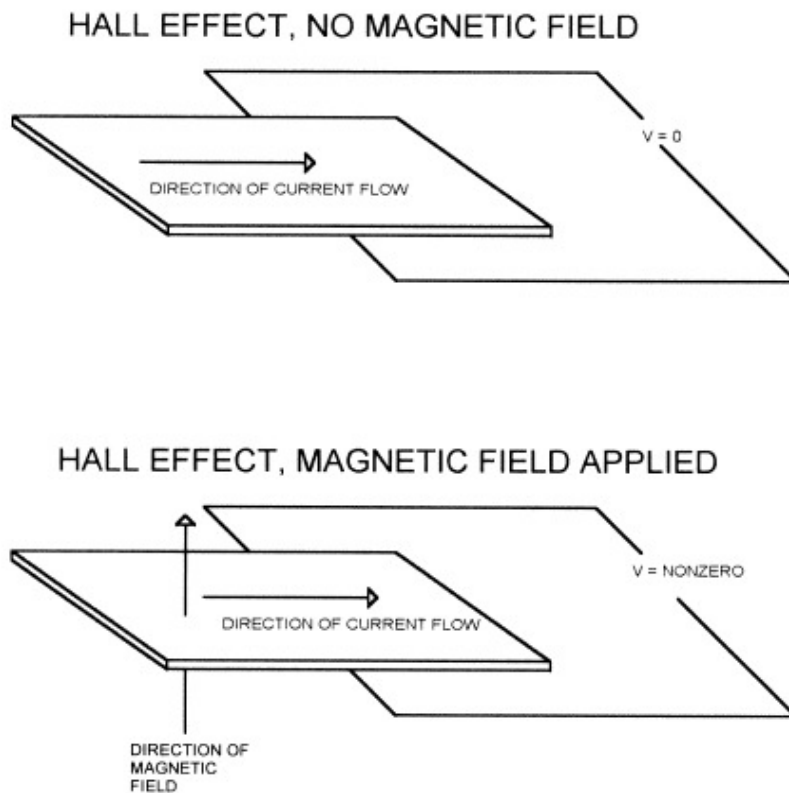
Optical Sensors

- Switches
- Isolators

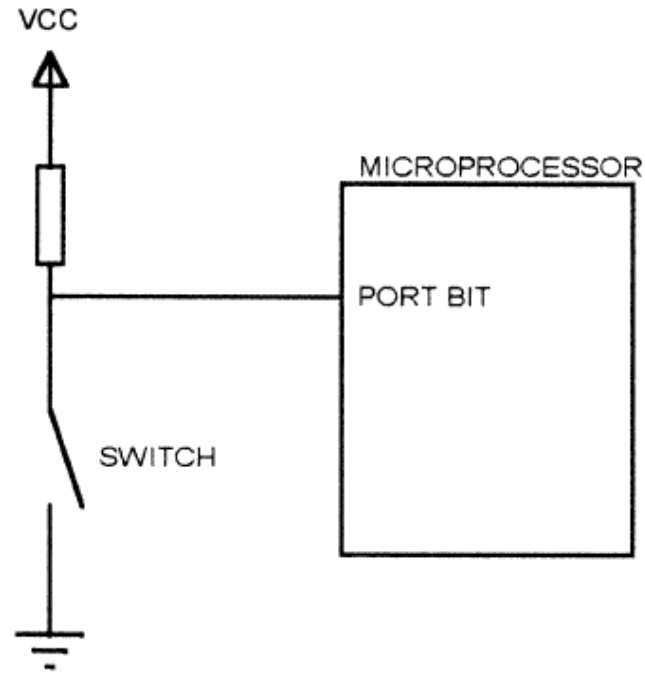


Magnetic Sensors

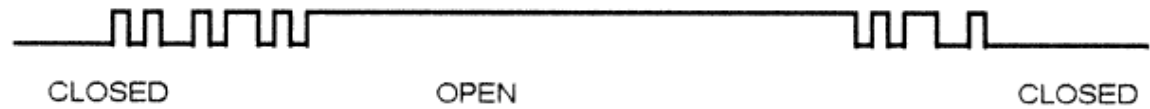
- LVDT
- Hall effect



Mechanical Switch



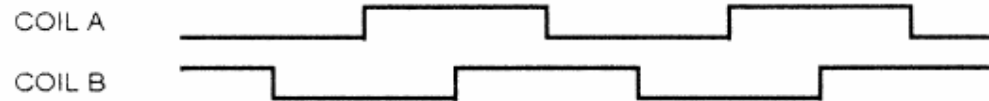
SWITCH OPEN/CLOSE WAVEFORM



Motor Interfacing

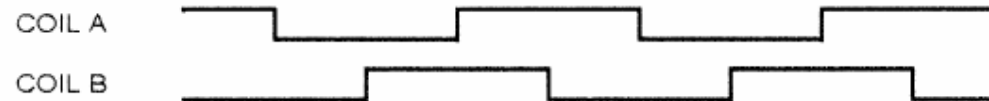
- Stepper motor

WAVEFORM
FORWARD ROTATION



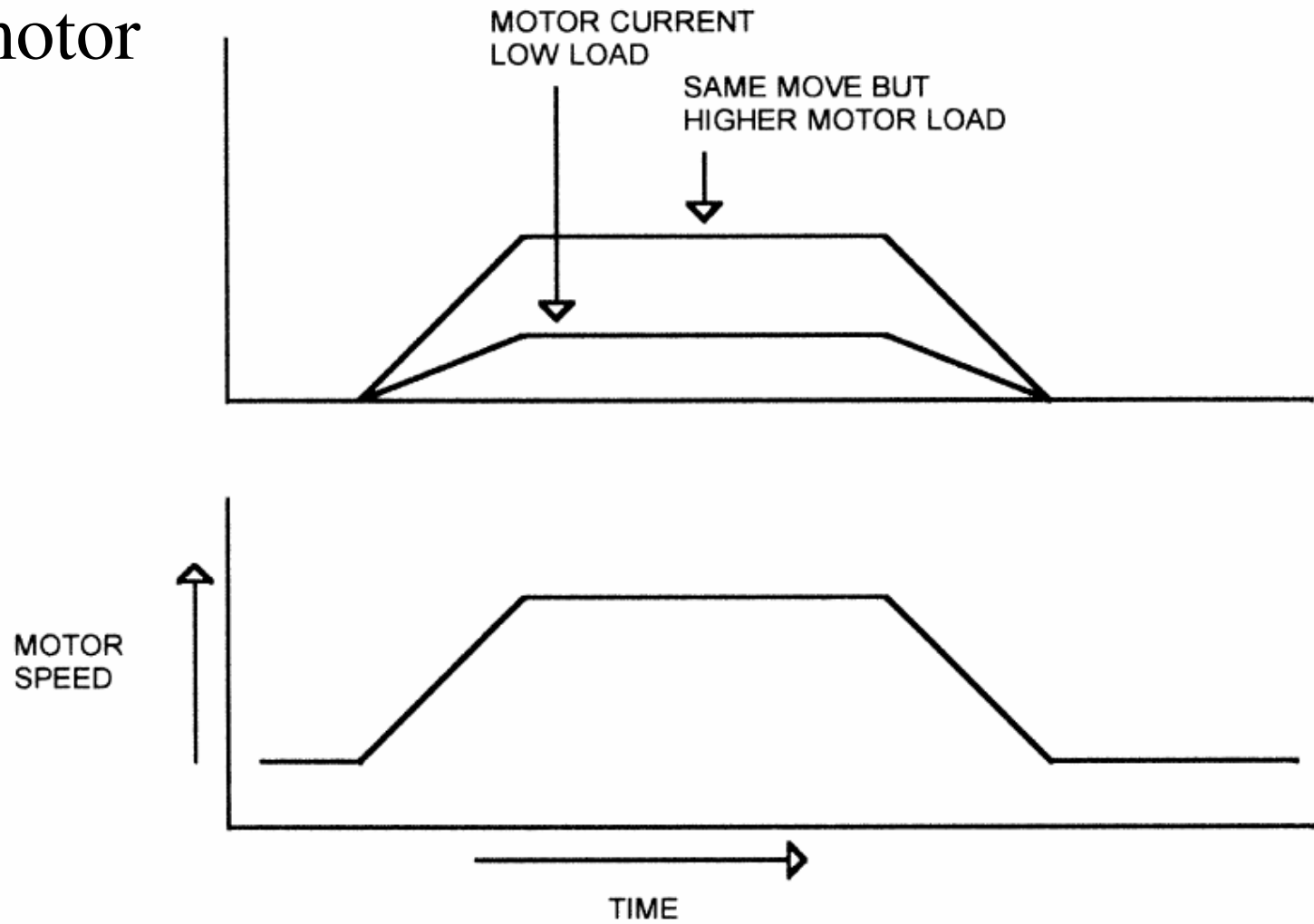
VOLTAGE A1	0V	+V	0V	+V	0V
VOLTAGE A2	+V	0V	+V	0V	+V
VOLTAGE B1	+V	0V	+V	0V	+V
VOLTAGE B2	0V	+V	0V	+V	0V

WAVEFORM
REVERSE ROTATION



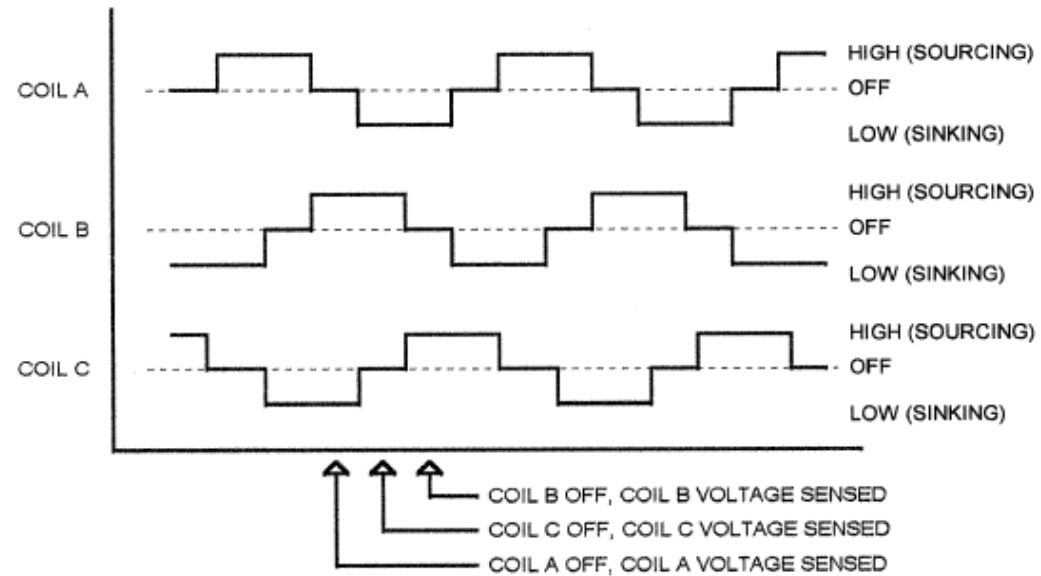
Motors

- DC motor

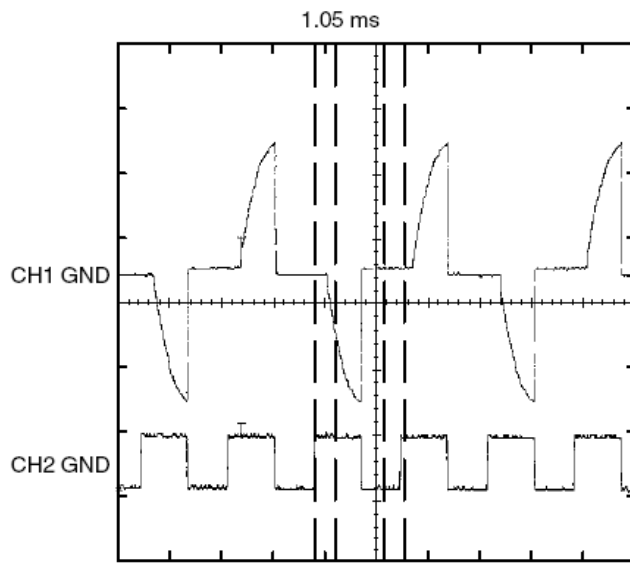
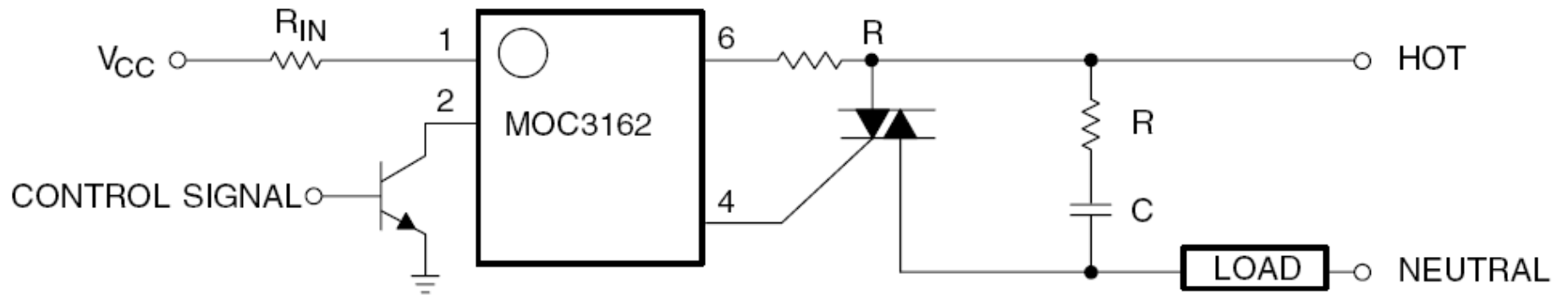


Motors

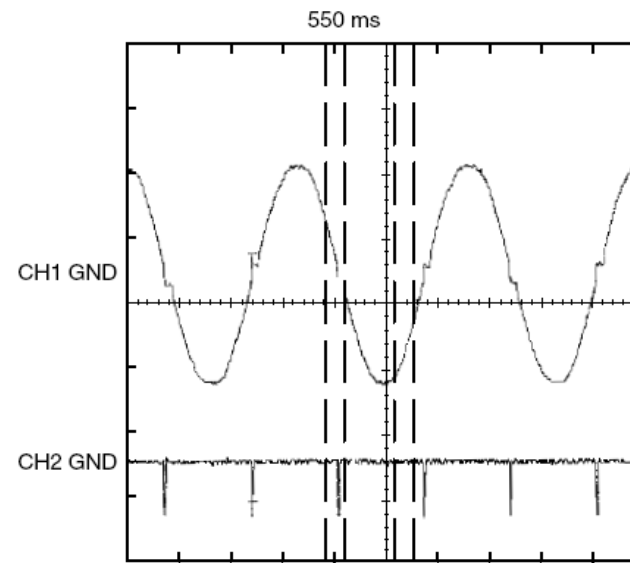
- Brushless DC



TRIACs



Time: 5 ms/div



Time: 5 ms/div

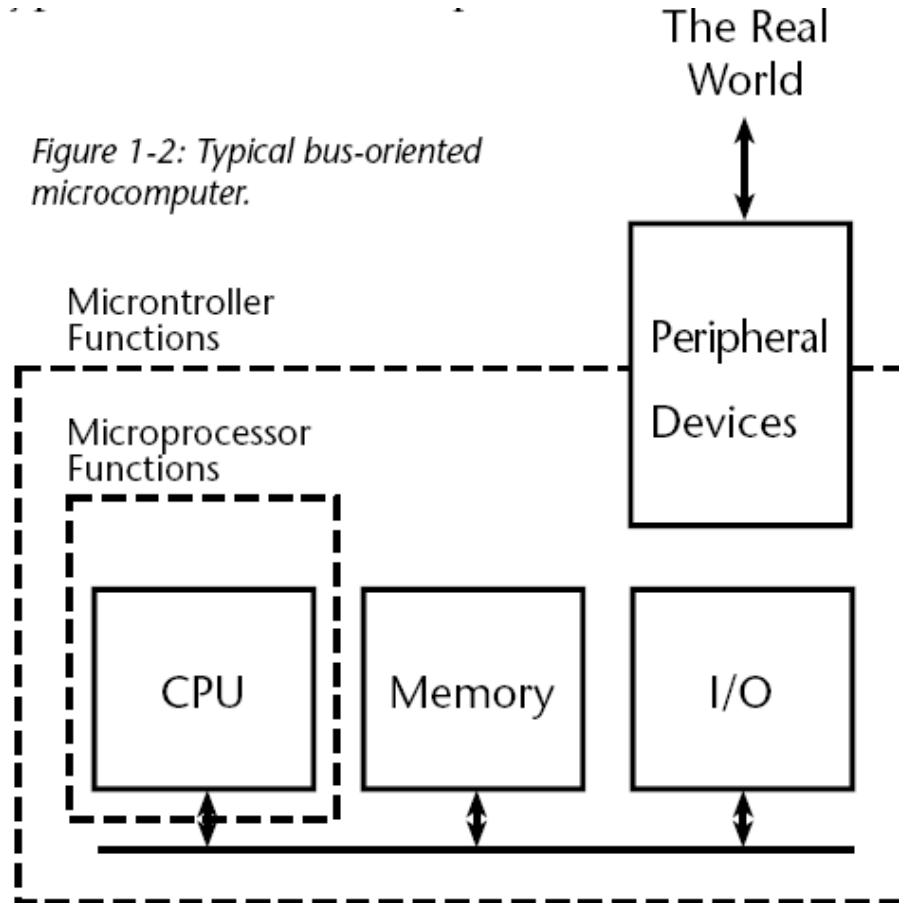
Microcontrollers

- Which microcontroller to use?
 - 8051
 - PIC
 - ARM
 - AD
 - TI

8051 Summary

- Selection of microcontroller
- Definition of pins
- Block diagram
- Instruction set
- Memory map
- I/O ports
- Timers
- Interrupts
- UART
- Practical development

Microcontroller Architecture



Microcontroller Selection

Table 1.1. Product Selection Guide

	MIPS (Peak)	FLASH Memory	RAM	External Memory Interface	SMBus/I ² C	SPI	UARTS	Timers (16-bit)	Programmable Counter Array	Digital Port I/O's	12-bit 100kps ADC Inputs	10-bit 100kps ADC Inputs	8-bit 500kps ADC Inputs	Voltage Reference	Temperature Sensor	DAC Resolution (bits)	DAC Outputs	Analog Comparators	Package
C8051F020	25	64k	4352	✓	✓	✓	2	5	✓	64	8	-	8	✓	✓	12	2	2	100TQFP
C8051F021	25	64k	4352	✓	✓	✓	2	5	✓	32	8	-	8	✓	✓	12	2	2	64TQFP
C8051F022	25	64k	4352	✓	✓	✓	2	5	✓	64	-	8	8	✓	✓	12	2	2	100TQFP
C8051F023	25	64k	4352	✓	✓	✓	2	5	✓	32	-	8	8	✓	✓	12	2	2	64TQFP

Pin Diagram

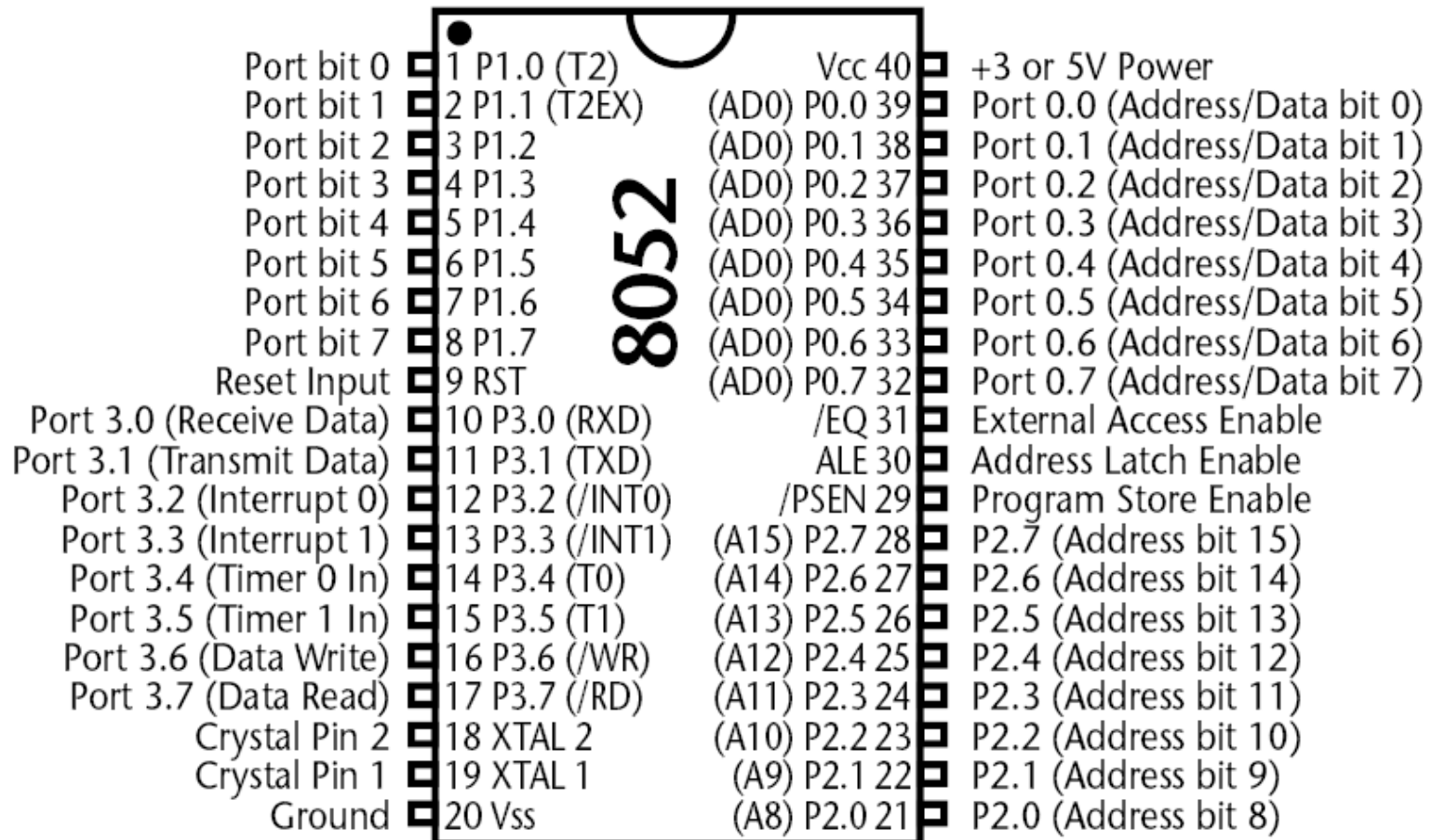
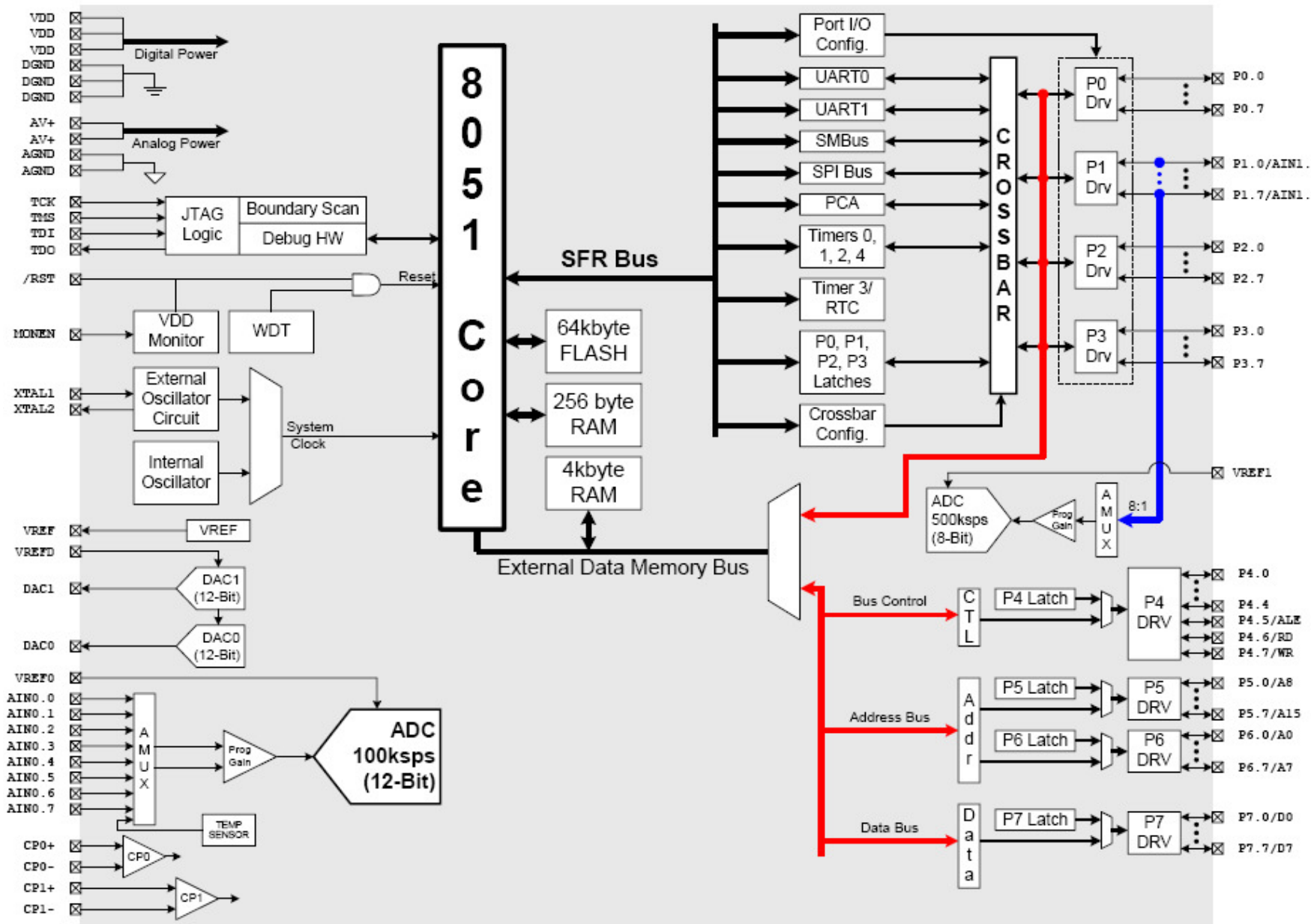


Table 4.1. Pin Definitions

Name	Pin Numbers		Type	Description
	F020	F021		
	F022	F023		
VDD	37, 64, 90	24, 41, 57		Digital Supply Voltage. Must be tied to +2.7 to +3.6 V.
DGND	38, 63, 89	25, 40, 56		Digital Ground. Must be tied to Ground.
AV+	11, 14	6		Analog Supply Voltage. Must be tied to +2.7 to +3.6 V.
AGND	10, 13	5		Analog Ground. Must be tied to Ground.
TMS	1	58	D In	JTAG Test Mode Select with internal pull-up.
TCK	2	59	D In	JTAG Test Clock with internal pull-up.
TDI	3	60	D In	JTAG Test Data Input with internal pull-up. TDI is latched on the rising edge of TCK.



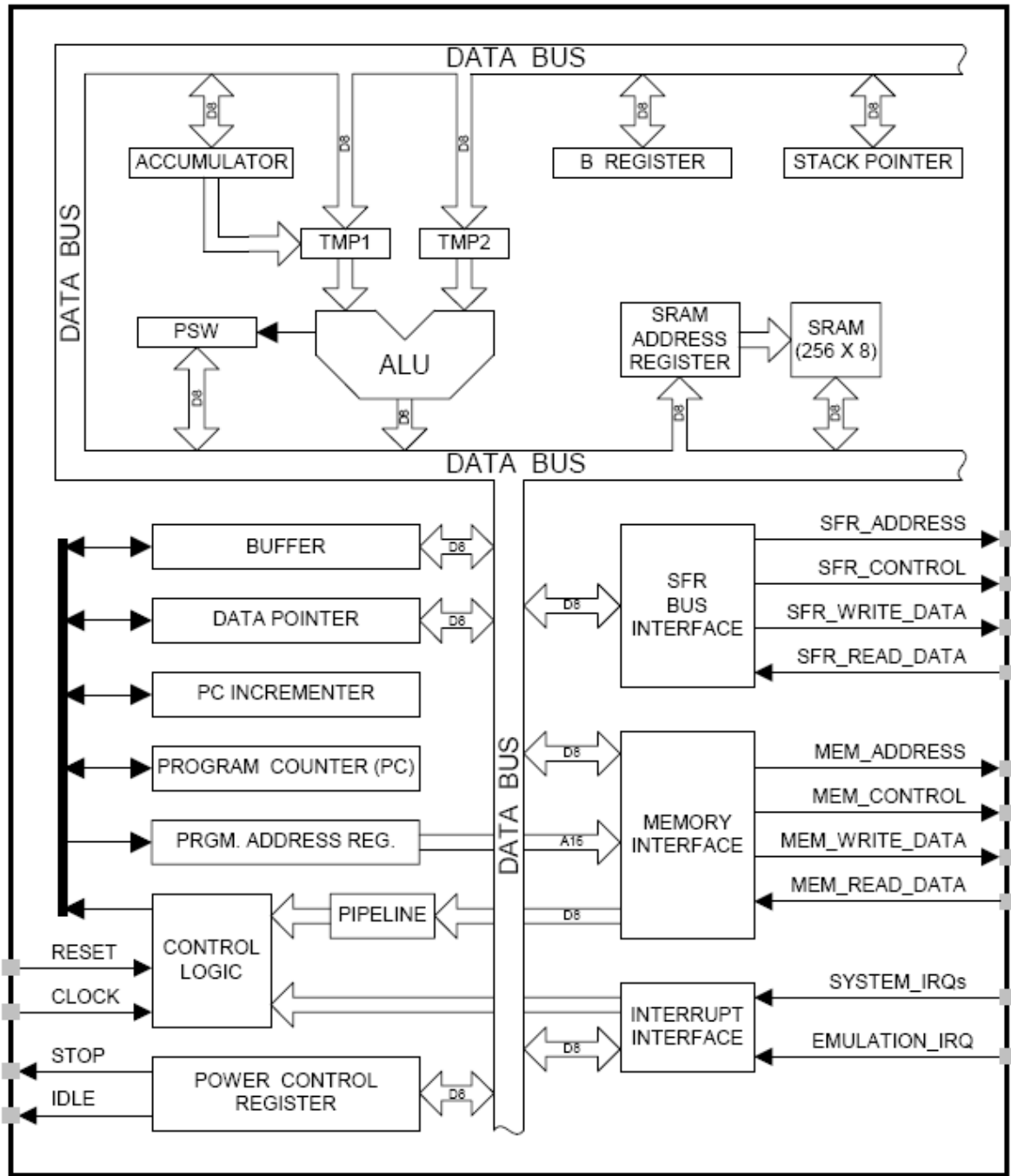


Table 12.1. CIP-51 Instruction Set Summary

Mnemonic	Description	Bytes	Clock Cycles
ARITHMETIC OPERATIONS			
ADD A, Rn	Add register to A	1	1
ADD A, direct	Add direct byte to A	2	2
ADD A, @Ri	Add indirect RAM to A	1	2
ADD A, #data	Add immediate to A	2	2
ADDC A, Rn	Add register to A with carry	1	1
ADDC A, direct	Add direct byte to A with carry	2	2
ADDC A, @Ri	Add indirect RAM to A with carry	1	2
ADDC A, #data	Add immediate to A with carry	2	2
SUBB A, Rn	Subtract register from A with borrow	1	1
SUBB A, direct	Subtract direct byte from A with borrow	2	2
SUBB A, @Ri	Subtract indirect RAM from A with borrow	1	2
SUBB A, #data	Subtract immediate from A with borrow	2	2
INC A	Increment A	1	1
INC Rn	Increment register	1	1
INC direct	Increment direct byte	2	2
INC @Ri	Increment indirect RAM	1	2
DEC A	Decrement A	1	1
DEC Rn	Decrement register	1	1
DEC direct	Decrement direct byte	2	2
DEC @Ri	Decrement indirect RAM	1	2
INC DPTR	Increment Data Pointer	1	1
MUL AB	Multiply A and B	1	4
DIV AB	Divide A by B	1	8
DA A	Decimal adjust A	1	1
LOGICAL OPERATIONS			
ANL A, Rn	AND Register to A	1	1
ANL A, direct	AND direct byte to A	2	2
ANL A, @Ri	AND indirect RAM to A	1	2
ANL A, #data	AND immediate to A	2	2
ANL direct, A	AND A to direct byte	2	2
ANL direct, #data	AND immediate to direct byte	3	3
ORL A, Rn	OR Register to A	1	1
ORL A, direct	OR direct byte to A	2	2
ORL A, @Ri	OR indirect RAM to A	1	2
ORL A, #data	OR immediate to A	2	2
ORL direct, A	OR A to direct byte	2	2
ORL direct, #data	OR immediate to direct byte	3	3
XRL A, Rn	Exclusive-OR Register to A	1	1
XRL A, direct	Exclusive-OR direct byte to A	2	2
XRL A, @Ri	Exclusive-OR indirect RAM to A	1	2

Table 12.1. CIP-51 Instruction Set Summary

Mnemonic	Description	Bytes	Clock Cycles
XRL A, #data	Exclusive-OR immediate to A	2	2
XRL direct, A	Exclusive-OR A to direct byte	2	2
XRL direct, #data	Exclusive-OR immediate to direct byte	3	3
CLR A	Clear A	1	1
CPL A	Complement A	1	1
RL A	Rotate A left	1	1
RLC A	Rotate A left through Carry	1	1
RR A	Rotate A right	1	1
RRC A	Rotate A right through Carry	1	1
SWAP A	Swap nibbles of A	1	1
DATA TRANSFER			
MOV A, Rn	Move Register to A	1	1
MOV A, direct	Move direct byte to A	2	2
MOV A, @Ri	Move indirect RAM to A	1	2
MOV A, #data	Move immediate to A	2	2
MOV Rn, A	Move A to Register	1	1
MOV Rn, direct	Move direct byte to Register	2	2
MOV Rn, #data	Move immediate to Register	2	2
MOV direct, A	Move A to direct byte	2	2
MOV direct, Rn	Move Register to direct byte	2	2
MOV direct, direct	Move direct byte to direct byte	3	3
MOV direct, @Ri	Move indirect RAM to direct byte	2	2
MOV direct, #data	Move immediate to direct byte	3	3
MOV @Ri, A	Move A to indirect RAM	1	2
MOV @Ri, direct	Move direct byte to indirect RAM	2	2
MOV @Ri, #data	Move immediate to indirect RAM	2	2
MOV DPTR, #data16	Load DPTR with 16-bit constant	3	3
MOVC A, @A+DPTR	Move code byte relative DPTR to A	1	3
MOVC A, @A+PC	Move code byte relative PC to A	1	3
MOVX A, @Ri	Move external data (8-bit address) to A	1	3
MOVX @Ri, A	Move A to external data (8-bit address)	1	3
MOVX A, @DPTR	Move external data (16-bit address) to A	1	3
MOVX @DPTR, A	Move A to external data (16-bit address)	1	3
PUSH direct	Push direct byte onto stack	2	2
POP direct	Pop direct byte from stack	2	2
XCH A, Rn	Exchange Register with A	1	1
XCH A, direct	Exchange direct byte with A	2	2
XCH A, @Ri	Exchange indirect RAM with A	1	2
XCHD A, @Ri	Exchange low nibble of indirect RAM with A	1	2
BOOLEAN MANIPULATION			
CLR C	Clear Carry	1	1
CLR bit	Clear direct bit	2	2
SETB C	Set Carry	1	1
SETB bit	Set direct bit	2	2
CPL C	Complement Carry	1	1

Table 12.1. CIP-51 Instruction Set Summary

Mnemonic	Description	Bytes	Clock Cycles
CPL bit	Complement direct bit	2	2
ANL C, bit	AND direct bit to Carry	2	2
ANL C, /bit	AND complement of direct bit to Carry	2	2
ORL C, bit	OR direct bit to carry	2	2
ORL C, /bit	OR complement of direct bit to Carry	2	2
MOV C, bit	Move direct bit to Carry	2	2
MOV bit, C	Move Carry to direct bit	2	2
JC rel	Jump if Carry is set	2	2/3
JNC rel	Jump if Carry is not set	2	2/3
JB bit, rel	Jump if direct bit is set	3	3/4
JNB bit, rel	Jump if direct bit is not set	3	3/4
JBC bit, rel	Jump if direct bit is set and clear bit	3	3/4
PROGRAM BRANCHING			
ACALL addr11	Absolute subroutine call	2	3
LCALL addr16	Long subroutine call	3	4
RET	Return from subroutine	1	5
RETI	Return from interrupt	1	5
AJMP addr11	Absolute jump	2	3
LJMP addr16	Long jump	3	4
SJMP rel	Short jump (relative address)	2	3
JMP @A+DPTR	Jump indirect relative to DPTR	1	3
JZ rel	Jump if A equals zero	2	2/3
JNZ rel	Jump if A does not equal zero	2	2/3
CJNE A, direct, rel	Compare direct byte to A and jump if not equal	3	3/4
CJNE A, #data, rel	Compare immediate to A and jump if not equal	3	3/4
CJNE Rn, #data, rel	Compare immediate to Register and jump if not equal	3	3/4
CJNE @Ri, #data, rel	Compare immediate to indirect and jump if not equal	3	4/5
DJNZ Rn, rel	Decrement Register and jump if not zero	2	2/3
DJNZ direct, rel	Decrement direct byte and jump if not zero	3	3/4
NOP	No operation	1	1

Notes on Registers, Operands and Addressing Modes:

Rn - Register R0-R7 of the currently selected register bank.

@Ri - Data RAM location addressed indirectly through R0 or R1.

rel - 8-bit, signed (two's complement) offset relative to the first byte of the following instruction. Used by SJMP and all conditional jumps.

direct - 8-bit internal data location's address. This could be a direct-access Data RAM location (0x00-0x7F) or an SFR (0x80-0xFF).

#data - 8-bit constant

#data16 - 16-bit constant

bit - Direct-accessed bit in Data RAM or SFR

addr11 - 11-bit destination address used by ACALL and AJMP. The destination must be within the same 2K-byte page of program memory as the first byte of the following instruction.

addr16 - 16-bit destination address used by LCALL and LJMP. The destination may be anywhere within the 64K-byte program memory space.

There is one unused opcode (0xA5) that performs the same function as NOP.
All mnemonics copyrighted © Intel Corporation 1980.

Figure 12.2. Memory Map

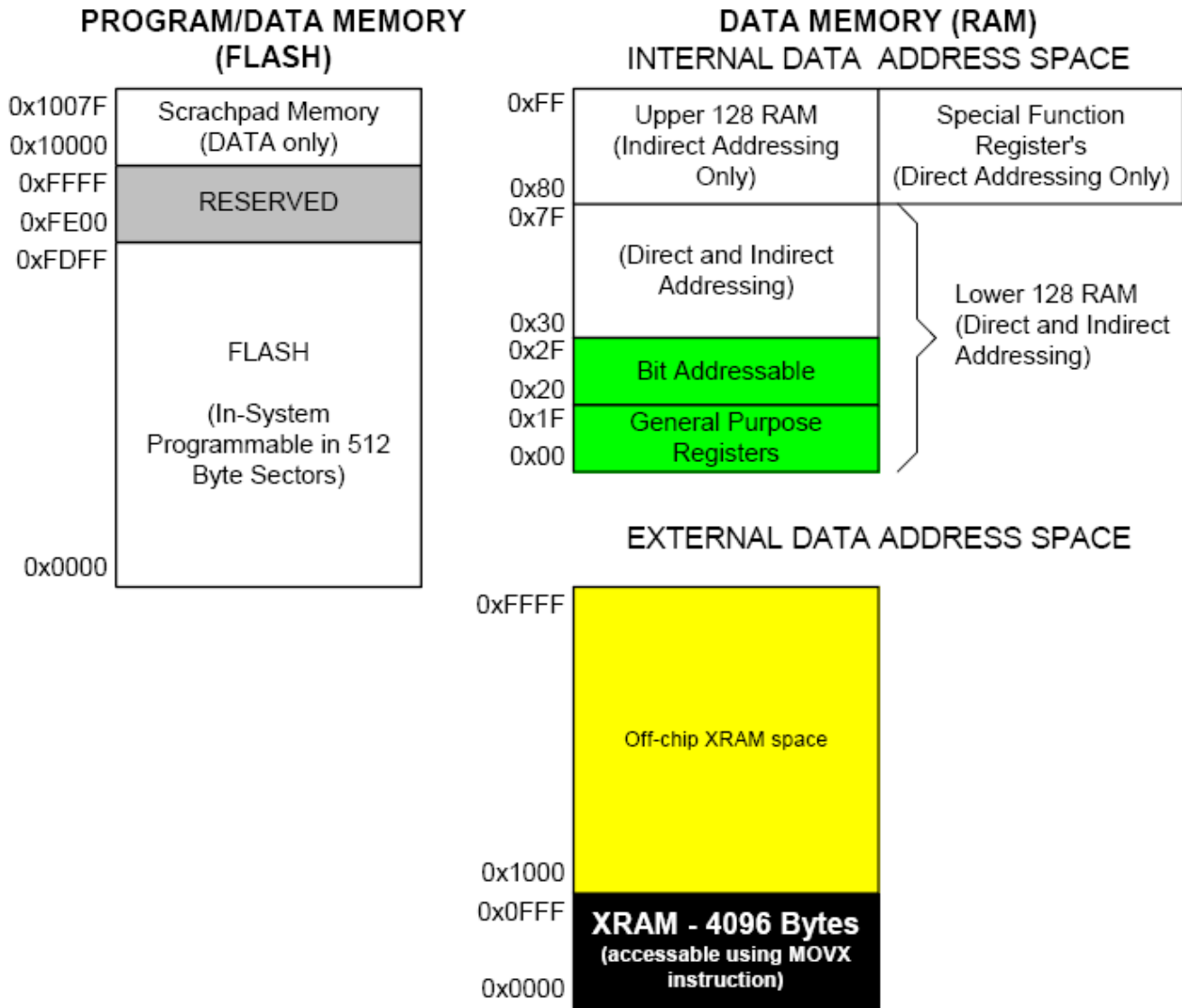


Table 12.2. Special Function Register (SFR) Memory Map

F8	SPI0CN	PCA0H	PCA0CPH0	PCA0CPH1	PCA0CPH2	PCA0CPH3	PCA0CPH4	WDTCN
F0	B	SCON1	SBUF1	SADDR1	TL4	TH4	EIP1	EIP2
E8	ADC0CN	PCA0L	PCA0CPL0	PCA0CPL1	PCA0CPL2	PCA0CPL3	PCA0CPL4	RSTSRC
E0	ACC	XBR0	XBR1	XBR2	RCAP4L	RCAP4H	EIE1	EIE2
D8	PCA0CN	PCA0MD	PCA0CPM0	PCA0CPM1	PCA0CPM2	PCA0CPM3	PCA0CPM4	
D0	PSW	REF0CN	DAC0L	DAC0H	DAC0CN	DAC1L	DAC1H	DAC1CN
C8	T2CON	T4CON	RCAP2L	RCAP2H	TL2	TH2		SMB0CR
C0	SMB0CN	SMB0STA	SMB0DAT	SMB0ADR	ADC0GTL	ADC0GTH	ADC0LTL	ADC0LTH
B8	IP	SADEN0	AMX0CF	AMX0SL	ADC0CF	P1MDIN	ADC0L	ADC0H
B0	P3	OSCXCN	OSICN			P74OUT†	FLSCL	FLACL
A8	IE	SADDR0	ADC1CN	ADC1CF	AMX1SL	P3IF	SADEN1	EMI0CN
A0	P2	EMI0TC		EMI0CF	P0MDOUT	P1MDOUT	P2MDOUT	P3MDOUT
98	SCON0	SBUF0	SPI0CFG	SPI0DAT	ADC1	SPI0CKR	CPT0CN	CPT1CN
90	P1	TMR3CN	TMR3RLL	TMR3RLH	TMR3L	TMR3H	P7†	
88	TCON	TMOD	TL0	TL1	TH0	TH1	CKCON	PSCTL
80	P0	SP	DPL	DPH	P4†	P5†	P6†	PCON
	0(8) (bit addressable)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)

Table 12.3. Special Function Registers

SFRs are listed in alphabetical order. All undefined SFR locations are reserved.

Register	Address	Description	Page No.
ACC	0xE0	Accumulator	page 115
ADC0CF	0xBC	ADC0 Configuration	page 49*, page 65**
ADC0CN	0xE8	ADC0 Control	page 50*, page 66**
ADC0GTH	0xC5	ADC0 Greater-Than High	page 53*, page 69**
ADC0GTL	0xC4	ADC0 Greater-Than Low	page 53*, page 69**
ADC0H	0xBF	ADC0 Data Word High	page 51*, page 67**
ADC0L	0xBE	ADC0 Data Word Low	page 51*, page 67**

Figure 12.7. ACC: Accumulator

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
ACC.7	ACC.6	ACC.5	ACC.4	ACC.3	ACC.2	ACC.1	ACC.0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xE0

Bits7-0: ACC: Accumulator.
This register is the accumulator for arithmetic operations.

Addressing Modes

*Table 2-1:
Implied addressing.*

Instruction	Operand
CPL complement	A accumulator
E4 (op code)	A (implied)

*Table 2-2:
Immediate addressing.*

Instruction	Operand
MOV A, load accumulator	#35H with 35 hex
74 (op code)	35 (constant)

Addressing Modes

Table 2-3:
Direct addressing.

Instruction	Operand
MOV A, load accumulator	34H with the contents of location 34
74 (op code)	35 (constant)

Table 2-3:
Indirect
addressing.

Instruction	Operand
MOVX A, load accumulator	@DPTR contains the address of the byte to be accessed
E0 (op code)	DPTR=1234h (address of the operand)

Table 12.4. Interrupt Summary

Interrupt Source	Interrupt Vector	Priority Order	Pending Flag	Bit addressable?	Cleared by HW?	Enable Flag	Priority Control
Reset	0x0000	Top	None	N/A	N/A	Always Enabled	Always Highest
External Interrupt 0 (/INT0)	0x0003	0	IE0 (TCON.1)	Y	Y	EX0 (IE.0)	PX0 (IP.0)
Timer 0 Overflow	0x000B	1	TF0 (TCON.5)	Y	Y	ET0 (IE.1)	PT0 (IP.1)
External Interrupt 1 (/INT1)	0x0013	2	IE1 (TCON.3)	Y	Y	EX1 (IE.2)	PX1 (IP.2)
Timer 1 Overflow	0x001B	3	TF1 (TCON.7)	Y	Y	ET1 (IE.3)	PT1 (IP.3)
UART0	0x0023	4	RI0 (SCON0.0) TI0 (SCON0.1)	Y		ES0 (IE.4)	PS0 (IP.4)
Timer 2 Overflow (or EXF2)	0x002B	5	TF2 (T2CON.7)	Y		ET2 (IE.5)	PT2 (IP.5)
Serial Peripheral Interface	0x0033	6	SPIF (SPI0CN.7)	Y		ESPI0 (EIE1.0)	PSPI0 (EIP1.0)
SMBus Interface	0x003B	7	SI (SMB0CN.3)	Y		ESMB0 (EIE1.1)	PSMB0 (EIP1.1)
ADC0 Window Comparator	0x0043	8	AD0WINT (ADC0CN.2)	Y		EWADC0 (EIE1.2)	PWADC0 (EIP1.2)
Programmable Counter Array	0x004B	9	CF (PCA0CN.7) CCFn (PCA0CN.n)	Y		EPCA0 (EIE1.3)	PPCA0 (EIP1.3)
Comparator 0 Falling Edge	0x0053	10	CP0FIF (CPT0CN.4)			ECP0F (EIE1.4)	PCP0F (EIP1.4)
Comparator 0 Rising Edge	0x005B	11	CP0RIF (CPT0CN.5)			ECP0R (EIE1.5)	PCP0R (EIP1.5)
Comparator 1 Falling Edge	0x0063	12	CP1FIF (CPT1CN.4)			ECP1F (EIE1.6)	PCP1F (EIP1.6)
Comparator 1 Rising Edge	0x006B	13	CP1RIF (CPT1CN.5)			ECP1R (EIE1.7)	PCP1R (EIP1.7)
Timer 3 Overflow	0x0073	14	TF3 (TMR3CN.7)			ET3 (EIE2.0)	PT3 (EIP2.0)
ADC0 End of Conversion	0x007B	15	AD0INT (ADC0CN.5)	Y		EADC0 (EIE2.1)	PADC0 (EIP2.1)
Timer 4 Overflow	0x0083	16	TF4 (T4CON.7)			ET4 (EIE2.2)	PT4 (EIP2.2)
ADC1 End of Conversion	0x008B	17	AD1INT (ADC1CN.5)			EADC1 (EIE2.3)	PADC1 (EIP2.3)
External Interrupt 6	0x0093	18	IE6 (P3IF.5)			EX6 (EIE2.4)	PX6 (EIP2.4)
External Interrupt 7	0x009B	19	IE7 (P3IF.6)			EX7 (EIE2.5)	PX7 (EIP2.5)
UART1	0x00A3	20	RI1 (SCON1.0) TI1 (SCON1.1)			ES1	PS1
External Crystal OSC Ready	0x00AB	21	XTLVLD (OSCXCN.7)			EXVLD (EIE2.7)	PXVLD (EIP2.7)

Figure 12.9. IE: Interrupt Enable

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
EA	IEGF0	ET2	ES0	ET1	EX1	ET0	EX0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: (bit addressable) 0xA8

Bit7: EA: Enable All Interrupts.
This bit globally enables/disables all interrupts. When set to '0', individual interrupt mask settings are overridden.
0: Disable all interrupt sources.
1: Enable each interrupt according to its individual mask setting.

Bit6: IEGF0: General Purpose Flag 0.
This is a general purpose flag for use under software control.

Bit5: ET2: Enabler Timer 2 Interrupt.
This bit sets the masking of the Timer 2 interrupt.
0: Disable Timer 2 interrupt.
1: Enable interrupt requests generated by the TF2 flag (T2CON.7).

Bit4: ES0: Enable UART0 Interrupt.
This bit sets the masking of the UART0 interrupt.
0: Disable UART0 interrupt.
1: Enable UART0 interrupt.

Bit3: ET1: Enable Timer 1 Interrupt.
This bit sets the masking of the Timer 1 interrupt.
0: Disable all Timer 1 interrupt.
1: Enable interrupt requests generated by the TF1 flag (TCON.7).

Bit2: EX1: Enable External Interrupt 1.
This bit sets the masking of external interrupt 1.
0: Disable external interrupt 1.
1: Enable interrupt requests generated by the /INT1 pin.

Bit1: ET0: Enable Timer 0 Interrupt.
This bit sets the masking of the Timer 0 interrupt.
0: Disable all Timer 0 interrupt.
1: Enable interrupt requests generated by the TF0 flag (TCON.5).

Bit0: EX0: Enable External Interrupt 0.
This bit sets the masking of external interrupt 0.
0: Disable external interrupt 0.
1: Enable interrupt requests generated by the /INT0 pin.

Figure 12.10. IP: Interrupt Priority

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	PT2	PS0	PT1	PX1	PT0	PX0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xB8

Bits7-6: UNUSED. Read = 11b, Write = don't care.

Bit5: PT2: Timer 2 Interrupt Priority Control.
This bit sets the priority of the Timer 2 interrupt.
0: Timer 2 interrupt priority determined by default priority order.
1: Timer 2 interrupts set to high priority level.

Bit4: PS0: UART0 Interrupt Priority Control.
This bit sets the priority of the UART0 interrupt.
0: UART0 interrupt priority determined by default priority order.
1: UART0 interrupts set to high priority level.

Bit3: PT1: Timer 1 Interrupt Priority Control.
This bit sets the priority of the Timer 1 interrupt.
0: Timer 1 interrupt priority determined by default priority order.
1: Timer 1 interrupts set to high priority level.

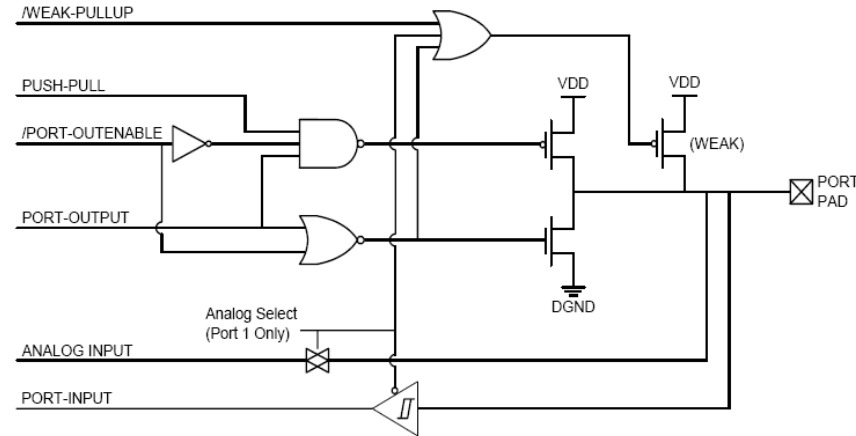
Bit2: PX1: External Interrupt 1 Priority Control.
This bit sets the priority of the External Interrupt 1 interrupt.
0: External Interrupt 1 priority determined by default priority order.
1: External Interrupt 1 set to high priority level.

Bit1: PT0: Timer 0 Interrupt Priority Control.
This bit sets the priority of the Timer 0 interrupt.
0: Timer 0 interrupt priority determined by default priority order.
1: Timer 0 interrupt set to high priority level.

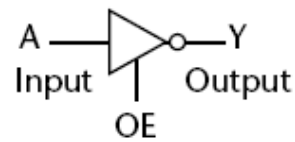
Bit0: PX0: External Interrupt 0 Priority Control.
This bit sets the priority of the External Interrupt 0 interrupt.
0: External Interrupt 0 priority determined by default priority order.
1: External Interrupt 0 set to high priority level.

I/O Ports

Figure 17.1. Port I/O Cell Block Diagram



Tri-State Inverting Buffer

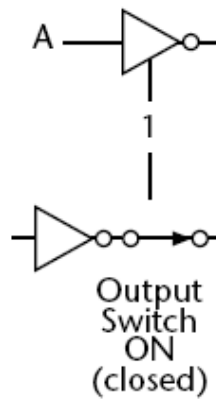


Truth Table

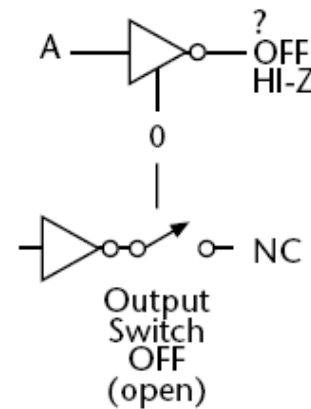
A	OE	Y	
0	1	1	
1	1	0	
0	0	?	Hi-Z
1	0	?	Hi-Z

Symbol and Function

Output ENabled



Output DISabled



Equivalent Circuit – Active and Passive

Figure 1-19: Active and passive states of a tri-state buffer.

Figure 17.10. P0: Port0 Data Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P0.7	P0.6	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0	11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x80
								(bit addressable)

Bits7-0: P0.[7:0]: Port0 Output Latch Bits.
 (Write - Output appears on I/O pins per XBR0, XBR1, XBR2, and XBR3 Registers)
 0: Logic Low Output.
 1: Logic High Output (open if corresponding P0MDOUT.n bit = 0).
 (Read - Regardless of XBR0, XBR1, XBR2, and XBR3 Register settings).
 0: P0.n pin is logic low.
 1: P0.n pin is logic high.

Note: P0.7 (/WR), P0.6 (/RD), and P0.5 (ALE) can be driven by the External Data Memory Interface. See **Section “16. EXTERNAL DATA MEMORY INTERFACE AND ON-CHIP XRAM” on page 145** for more information. See also Figure 17.9 for information about configuring the Crossbar for External Memory accesses.

Figure 17.11. P0MDOUT: Port0 Output Mode Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xA4

Bits7-0: P0MDOUT.[7:0]: Port0 Output Mode Bits.
 0: Port Pin output mode is configured as Open-Drain.
 1: Port Pin output mode is configured as Push-Pull.

Note: SDA, SCL, and RX0 (when UART0 is in Mode 0) and RX1 (when UART1 is in Mode 0) are always configured as Open-Drain when they appear on Port pins.

Timer 0 and Timer 1:	Timer 2:	Timer 3:	Timer 4
13-bit counter/timer	16-bit counter/timer with auto-reload	16-bit timer with auto-reload	16-bit counter/timer with auto-reload
16-bit counter/timer	16-bit counter/timer with capture		16-bit counter/timer with capture
8-bit counter/timer with auto-reload	Baud rate generator for UART0		Baud rate generator for UART1
Two 8-bit counter/timers (Timer 0 only)			

Figure 22.7. TL0: Timer 0 Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x8A

Bits 7-0: TL0: Timer 0 Low Byte.
The TL0 register is the low byte of the 16-bit Timer 0.

Figure 22.9. TH0 Timer 0 High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x8C

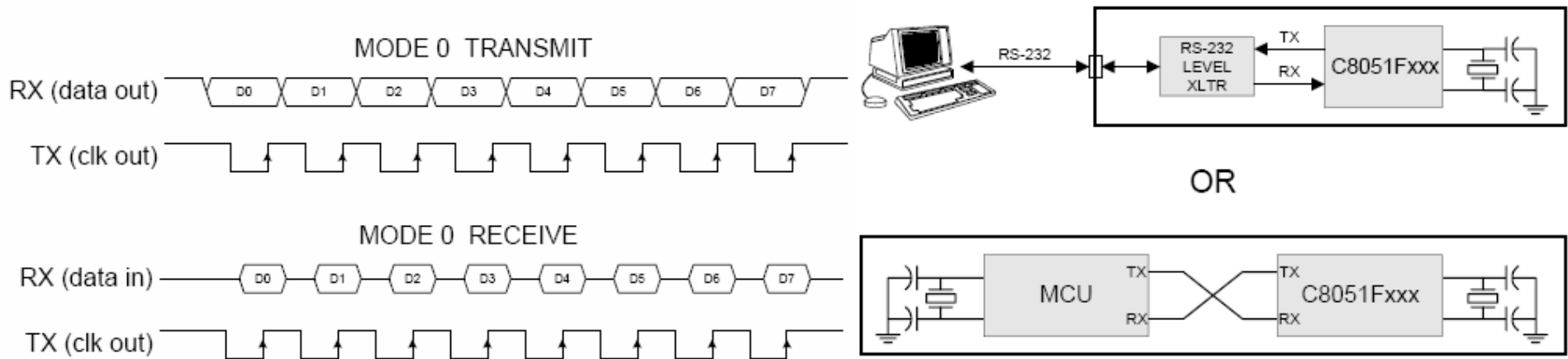
Bits 7-0: TH0: Timer 0 High Byte.
The TH0 register is the high byte of the 16-bit Timer 0.

UART

Table 20.1. UART0 Modes

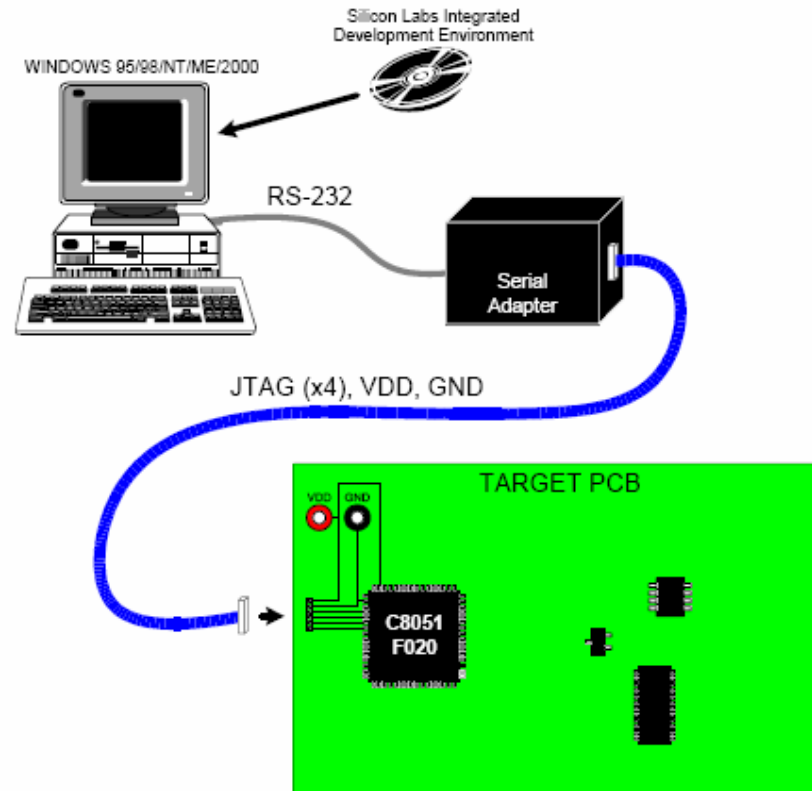
Mode	Synchronization	Baud Clock	Data Bits	Start/Stop Bits
0	Synchronous	$\text{SYSCLK} / 12$	8	None
1	Asynchronous	Timer 1 or 2 Overflow	8	1 Start, 1 Stop
2	Asynchronous	$\text{SYSCLK} / 32$ or $\text{SYSCLK} / 64$	9	1 Start, 1 Stop
3	Asynchronous	Timer 1 or 2 Overflow	9	1 Start, 1 Stop

Figure 20.3. UART0 Mode 0 Timing Diagram



Practical Development

Figure 1.8. Development/In-System Debug Diagram



Standard Software Development Process

1. Create or edit an ASCII text file containing the human readable source code, also known as the program instructions.
2. Translate the source code to machine-readable binary instruction code using a language translator. This is accomplished using an assembler or compiler.
3. Load the program memory with the binary instruction code into the processor's program memory chip. For the SDK, the program is downloaded into program memory on the SDK.
4. Execute the program to test it and find program errors. For the SDK, this "debugging" process is facilitated using a special program (debugger or monitor) resident on the SDK.
5. Once the problem is located, the source code is corrected by repeating this process until all errors are corrected.

